GlobalFoundries 12LP/LP+ & 22FDX EFLX®4K eFPGA Tiles

The EFLX[®]4K Tile is an embeddable standalone FPGA IP core, with 2 versions, that communicates with the rest of your SoC using input and output pins on the edges. For more logic capacity we can abut tiles to make larger arrays (up to ~8x8) with any combination of tile versions.

EFLX EFLX 4K LGC 4K LGC EFLX 4K DSP EFLX 4K DSP EFLX 4K DSF EFLX 4K DSP EFLX 4K DSP EFLX 4K DSF EFLX 4K DSF EFLX 4K LGC EFLX 4K DSP EFLX 4K DSP EFLX 4K DSF EFLX 4K DSP EFLX 4K DSP EFLX 4K DSP EFLX 4K DSP EFLX 4K LGC EFLX 4K LGC

The two versions of the EFLX tile are described below – they are all the same dimensions so they can be intermixed in arrays. The DSP MAC is a 22x22 multiplier with 48-bit accumulator arranged in 4 row of 10 pipelined MACs.

EFLX 4K Versions:	EFLX 4K Logic Tile	EFLX 4K DSP Tile
Clocks	2 clocks/tile; 2N clocks for an N tile array (Gen 2.4 will have 4x)	
Look-upTables	2,520	1,880
(6-input LUT with 2 independent outputs)	(~4.0K LUT4)	(~3.0K LUT4)
Total Flips Flops (ex DSP MACs)	6,304	5,024
Distributed Memory	21 Kbits	1 Kbits
22-bit DSP MACs	0	40
I/O Pins, with optional flip flop	632 input & 632 output	

The EFLX 4K tiles have numerous input and output pins. Each input or output pin has a bypassable flip flop. When multiple cores are concatenated into EFLX arrays, the pins along the abutting edges are disabled or are used for controlling embedded RAM blocks (BRAMs).



Besides input/output pins, there are clock, configuration, and test/DFT pins. Each Core has an

EFLX 4K Logic/DSP input/output map (IO tile has more IO top+bottom)

internal power grid which can be connected to the customer's digital SoC power grid. The Core also has configuration inputs on the West side and configuration inputs on the South side to load the bitstream. An AXI or JTAG interface is available for configuration. A clock mesh provides multiple connection points. The configuration bits can be read back anytime to enable checking for soft errors to improve reliability for high-reliability applications.

August 2023. Copyright 2014-2023 Flex Logix[®] Technologies, Inc. EFLX[®], Flex Logix[®], XFLX, ArrayLinx are Trademarks of Flex Logix Technologies



Node	GF12LP/12LP+		P+	GF22FDX
EFLX Generation	2.0	2.0	2.0	2.3
Clocks	2 clocks/tile, 2N clocks for an N-tile array			2 clocks/tile, 2N clocks for an N-tile array
Special Features	Single Rail	Dual Rail for external power gating	Rad Hard by Design	Forward body bias support
Metal Stack	3Mx_2Cx_4Kx		(9M_2Mx_3Cx_2Bx_11x_10x
	IP top layer: K4 (M9)		M9)	IP top layer: OI (M9)
Nominal Supply Voltages (Vj)	0.6, 0.7, 0.8, 0.9		9	0.8
Temperature Range	-40° to +125° C Tj			
Availability	Silicon Validated		ed	Available
Leakage Power	7.2 mW (TT, 0.8Vj, 25C Tj) 10.6 mW (TT, 0.8Vj, 25C Tj) 0.8Vj, 25C Tj)		10.6 mW (TT, 0.8Vj, 25C Tj)	1.1 mW (TT, 0.8Vj, 25C Tj) est.
Area (mm ²)	1.24	1.36	1.57	2.66

Evaluation Licenses are available free for you to try your RTL on our EFLX Compiler for your node/array size/features to check performance: timing is available for multiple process corners.

When you integrate ELFX eFPGA into your SoC/ASIC, our engineering team will work closely with you. We have a detailed architectural specification and numerous deliverables. We help you with design, DFT and production test. We are with you all the way through production ramp.

Deliverables and EDA Design Views				
Front-end Design view (with NDA)	Back-end Design Views (with License)			
Encrypted Varilag Natlict	Encrypted Verilog Netlist with Timing Annotation &			
	SDF			
LIB	GDS-II			
Footprint LEF	CDL/Spice netlist			
Detailed datasheet & DSP User's Guide	Integration guidelines & assistance			
Silicon validation report available	Test Vectors for DFT test coverage			
EFLX Compiler evaluation version	EFLX Compiler bitstream generation version			

Evaluation boards are available for some process nodes.

August 2023. Copyright 2014-2023 Flex Logix Technologies, Inc.

